# 2SD0875G

### Silicon NPN epitaxial planar type

For low-frequency power amplification Complementary to 2SB0767G

#### Features

- $\bullet$  Large collector power dissipation  $P_{\rm C}$
- $\bullet$  High collector-emitter voltage (Base open)  $V_{\mbox{CEO}}$
- Mini power type package, allowing downsizing of the equipment and automatic insertion through the tape packing and the magazine packing.

Absolute Maximum Hatings $I_a = 25$ C						
Parameter	Symbol	Rating	Unit			
Collector-base voltage (Emitter open)	V <sub>CBO</sub>	80	V			
Collector-emitter voltage (Base open)	V <sub>CEO</sub>	80	V			
Emitter-base voltage (Collector open)	V <sub>EBO</sub>	5	V			
Collector current	I <sub>C</sub>	0.5	Α			
Peak collector current	I <sub>CP</sub>	1	A			
Collector power dissipation *	P <sub>C</sub>	1	W			
Junction temperature	Tj	150	۰°C			
Storage temperature	T <sub>stg</sub>	-55 to +150	ું <sub>દ</sub> ે			

#### Absolute Maximum Ratings $T_a = 25^{\circ}C$

- Package
- Code
- MiniP3-F2
- Pin Name
  - 1: Base
  - 2: Collector
  - 3: Emitter

Marking Symbol: X

Note) \*: Printed circuit board: Copper foil area of 1 cm<sup>2</sup> or more, and the board thickness of 1.7 mm for the collector portion

#### Electrical Characteristics $T_a = 25^{\circ}C \pm 3^{\circ}C$

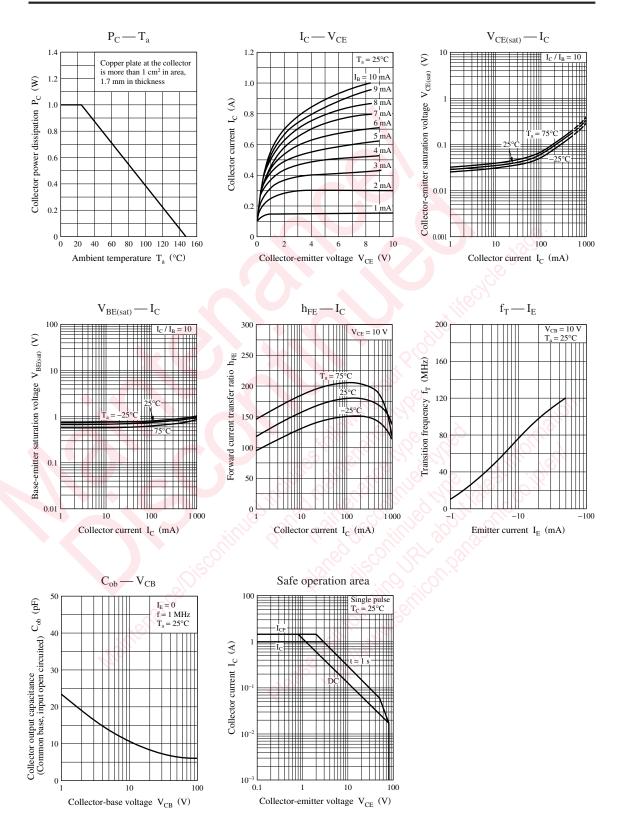
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Collector-base voltage (Emitter open)	V <sub>CBO</sub>	$I_{\rm C} = 10 \ \mu A, I_{\rm E} = 0$	80			V
Collector-emitter voltage (Base open)	V <sub>CEO</sub>	$I_{\rm C} = 100 \ \mu \text{A}, I_{\rm B} = 0$	80			V
Emitter-base voltage (Collector open)	V <sub>EBO</sub>	$I_{\rm E} = 10 \ \mu A, I_{\rm C} = 0$	5			V
Collector-base cutoff current (Emitter open)	I <sub>CBO</sub>	$V_{CB} = 20 \text{ V}, I_E = 0$			0.1	μΑ
Forward current transfer ratio	h <sub>FE1</sub> *	$V_{CE} = 10 \text{ V}, \text{ I}_{C} = 150 \text{ mA}$	130		330	_
	h <sub>FE2</sub>	$V_{CE} = 50 \text{ V}, I_{C} = 500 \text{ mA}$	50			
Collector-emitter saturation voltage	V <sub>CE(sat)</sub>	$I_{\rm C} = 300 \text{ mA}, I_{\rm B} = 30 \text{ mA}$		0.2	0.4	V
Base-emitter saturation voltage	V <sub>BE(sat)</sub>	$I_{\rm C} = 300 \text{ mA}, I_{\rm B} = 30 \text{ mA}$		0.85	1.2	V
Transition frequency	f <sub>T</sub>	$V_{CB} = 10 \text{ V}, I_E = -50 \text{ mA}, f = 200 \text{ MHz}$		120		MHz
Collector output capacitance	C <sub>ob</sub>	$V_{CB} = 10 \text{ V}, I_E = 0, f = 1 \text{ MHz}$		11	20	pF
(Common base, input open circuited)						

Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

2. \*: Rank classification

Rank	R	S
$h_{\rm FE1}$	130 to 220	185 to 330

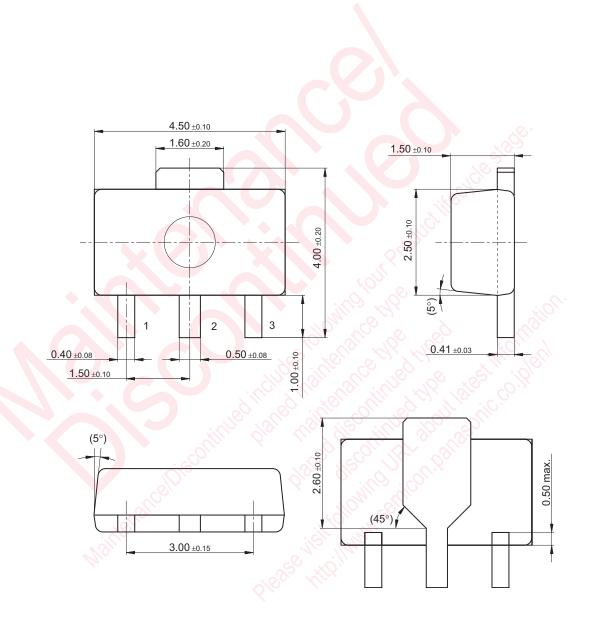
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MiniP3-F2

Unit: mm



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